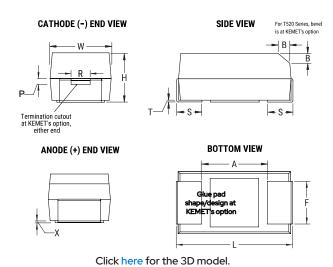


T520D157M006ATE007

General Information

Sarias

T520, Tantalum, Polymer Tantalum, Commercial Grade, 150 uF, 20%, 6.3 VDC, SMD, Polymer, Molded, Low ESR, Non-Combustible, 7 mOhms, 7343, 3.1 mm, 1.3 mm



Dielectric Polymer Tantalum Style SMD Chip Description SMD, Polymer, Molded, Low ESR, Non-Combustible Features Low ESR RoHS Yes Termination Tin AEC-Q200 No Typical Component Weight 434.83 mg Shelf Life 52 Weeks MSL 3	Series	1520
Description SMD, Polymer, Molded, Low ESR, Non-Combustible Features Low ESR RoHS Yes Termination Tin AEC-Q200 No Typical Component Weight Shelf Life SMD, Polymer, Molded, Low ESR No ESR Ves Test Substituting Sub	Dielectric	Polymer Tantalum
ESR, Non-Combustible Features Low ESR RoHS Yes Termination Tin AEC-Q200 No Typical Component Weight 434.83 mg Shelf Life 52 Weeks	Style	SMD Chip
RoHS Yes Termination Tin AEC-Q200 No Typical Component Weight 434.83 mg Shelf Life 52 Weeks	Description	
Termination Tin AEC-Q200 No Typical Component Weight 434.83 mg Shelf Life 52 Weeks	Features	Low ESR
AEC-Q200 No Typical Component Weight 434.83 mg Shelf Life 52 Weeks	RoHS	Yes
Typical Component Weight 434.83 mg Shelf Life 52 Weeks	Termination	Tin
Shelf Life 52 Weeks	AEC-Q200	No
	Typical Component Weight	434.83 mg
MSL 3	Shelf Life	52 Weeks
	MSL	3

T520

Dimensions	
L	7.3mm +/-0.3mm
W	4.3mm +/-0.3mm
Н	2.8mm +/-0.3mm
Т	0.13mm REF
S	1.3mm +/-0.3mm
F	2.4mm +/-0.1mm
A	3.8mm MIN
В	0.5mm +/-0.15mm
Р	0.9mm REF
R	1mm REF
Х	0.1mm +/-0.1mm REF

Specifications				
Capacitance	150 uF			
Tolerance	20%			
Voltage DC	6.3 VDC (105C)			
Temperature Range	-55/+105°C			
Rated Temperature	105°C			
Life	2000 Hrs (105C)			
Humidity	60C, 90% RH, 500 Hours, No Load			
Dissipation Factor	10% 120Hz 25C			
Failure Rate	N/A			
ESR	7 mOhms (100kHz 25C)			
Ripple Current	5700 mA (rms, 100kHz 45C), 3990 mA (rms, 85C), 1425 mA (rms, 105C)			
Leakage Current	94.5 uA (5min 25°C)			

Packaging Specifications		
Packaging	T&R, 178mm	
Packaging Quantity	500	

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.

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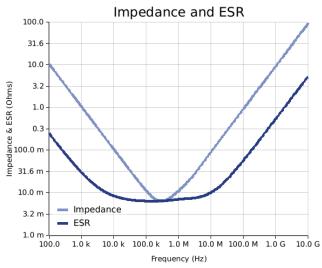


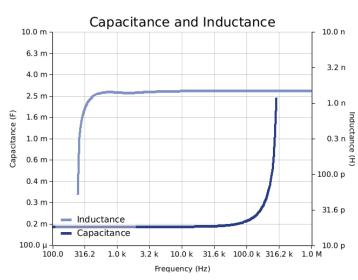
T520D157M006ATE007

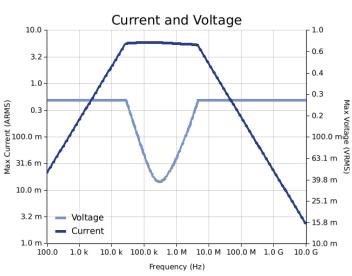
T520, Tantalum, Polymer Tantalum, Commercial Grade, 150 uF, 20%, 6.3 VDC, SMD, Polymer, Molded, Low ESR, Non-Combustible, 7 mOhms, 7343, 3.1 mm, 1.3 mm

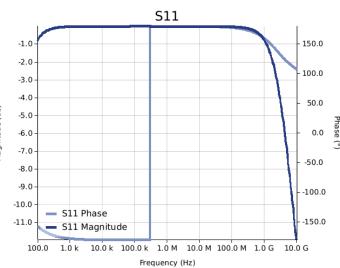
Simulations

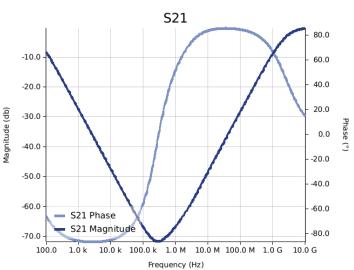
For the complete simulation environment please visit Y-SIM.











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These are simulations.

This is not a specification!

The responses shown represent the typical response for each part type. Specific responses may vary, depending on manufacturing variation affects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.

The responses shown do not represent a specified or implied maximum capability of the device for all applications.

- The ESR used for ripple "Ripple Current/Voltage vs. Frequency" plots is the ESR at ambient temperature.

- The ESR in the "Temperature Rise vs. Ripple Current" plots is the ESR at ambient temperature. The ESR in the "Temperature Rise vs. Ripple Current" plots is adjusted to each incremental temperature rise before the power and ripple current is calculated. The effects shown herein are based on measured data from a multiple part sample of the parts in question. Ripple capability of this device will be factored by thermal resistance (Rth) created by circuit traces (addi affects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.

 The peak voltages generated in the "Temperature Rise vs. Combined Ripple Currents" plot are calculated for each frequency and are not combined with voltages
- generated at any other harmonics.

 Please consult with the catalog or field applications engineer for maximum capability of the device in specific applications.

All product information and data (collectively, the "Information") are subject to change without notice.

KEMET K-SIM is designed to simulate behavior of components with respect to frequency, ambient temperature, and DC bias levels. The responses shown represent the typical response for each part type. Specific responses may vary, depending on manufacturing variation effects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.

All Information given herein is believed to be accurate and reliable, but is presented without guarantee, warranty, or responsibility of any kind, expressed or implied. Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute – and we specifically disclaim – any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.

If you have any questions please contact K-SIM.

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